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(54) **TRANSPARENT CONDUCTIVE FILM**

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(57) **ABSTRACT**

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A transparent conductive film 1 comprises a transparent plastic film 2 and a transparent conductive layer 4 laminated to at least one surface of the transparent plastic film 2. The transparent conductive film 1, as a whole, has a haze value of 8 or less; and at least one of the two surfaces of the transparent plastic film 2, that is, the surface to which the transparent conductive film 4 is laminated and the other surface, is provided with fine irregularities having a maximum height (Rmax) of 0.5 to 2.0 μm. These fine irregularities preferably have a ten-point mean roughness (Rz) of 0.35 to 1.5 μm. The fine irregularities may be provided as the surface structure of a fine irregularity layer 3 laminated to one surface of the transparent plastic film 2. The transparent conductive layer 4 may be laminated to the surface of the fine irregularity layer 3 formed on the transparent plastic film 2, or to the surface of the transparent plastic film 2 to which the fine irregularity layer 3 is not laminated.

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